

ELECTRONIC OBJECT**ABSTRACT**

The electronic object (10) comprises, in a first embodiment, a system carrier (14) for acceptance of an electronic element and a body (12) made of injected plastic. The system carrier (14) has a contact pad (16) which lies in an outer surface of the electronic object (10) and is connected to the rest of the system carrier (14) via at least one bend (19). In the area of this bend (19) it has a backward projecting step (30) on its outer surface (17) the upper edge (31) of which forms a border between the plastic and the contact pad (16).

The electronic object (10) comprises, in a second embodiment, a system carrier (14) with an electronic element (40). This is surrounded by a plastic capsule (44) whereby the plastic for the plastic capsule (44) is supplied free-flowing. The electronic element (40) is mounted in a recess of the system carrier (14) or a recess (34) in the system carrier (14) surrounds the electronic element (40). On applying the plastic in free-flowing form for forming the plastic capsule (44) the step (30) formed by the recess (34) effects the stopping of the flowing plastic at the recess (34) and thus a high reproducibility of the size and shape of the afterwards cured plastic capsule (44) is achieved.

(Fig. 3A, Fig. 9)

This Sheet Has Been Replaced

